

Release HS 20 W

(Provisional)

Description

RELEASE HS 20 W is a water-borne product, suitable for hot-stamping applications.

Application

RELEASE HS 20 W is designed to be coated on BOPET. It provides a good adhesion for metalization and/or printing and allows an easy release after the heat transfer step.

Use within 6 months from production date (unopened and in the original packaging).

Technical Specifications

Method of analysis	MU	Standard
1. Total Solids	%	20±1
3. Brookfield Viscosity 25°C	mPa.s	< 300
8. pH	pH	6 - 8
- Solvents		water

Handling

Apply 6-7 g/sqm wet on the film with traditional coating systems (rotogravure, Mayer bar,...).

Packaging

The product is supplied in iron drums (200 kg); IBC containers (1000 kg).

Storing

Protect from freeze. Keep at temperatures between +5 and +40°C.